

1. Description

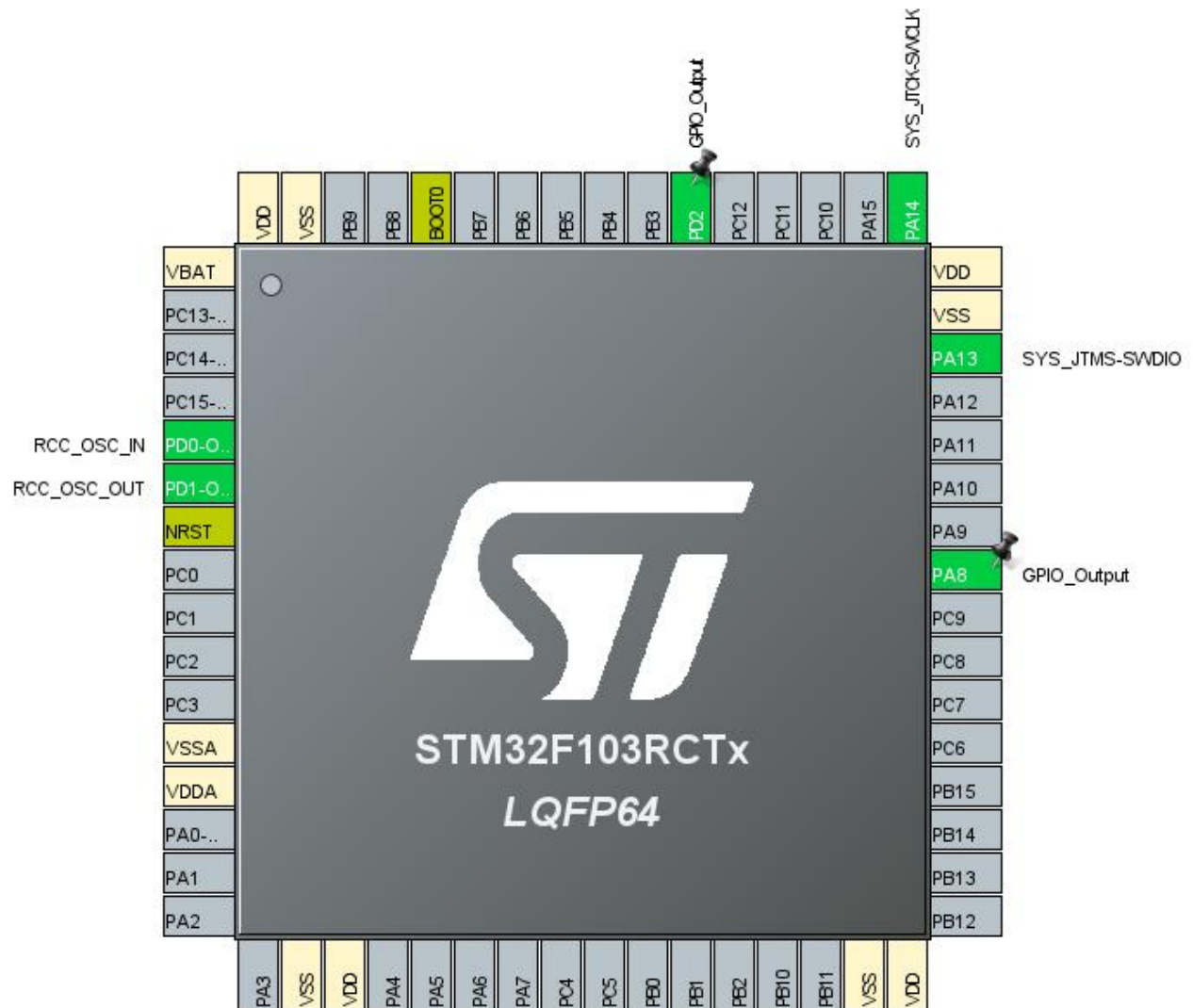
1.1. Project

Project Name	lab1
Board Name	custom
Generated with:	STM32CubeMX 5.6.0
Date	09/16/2020

1.2. MCU

MCU Series	STM32F1
MCU Line	STM32F103
MCU name	STM32F103RCTx
MCU Package	LQFP64
MCU Pin number	64

2. Pinout Configuration

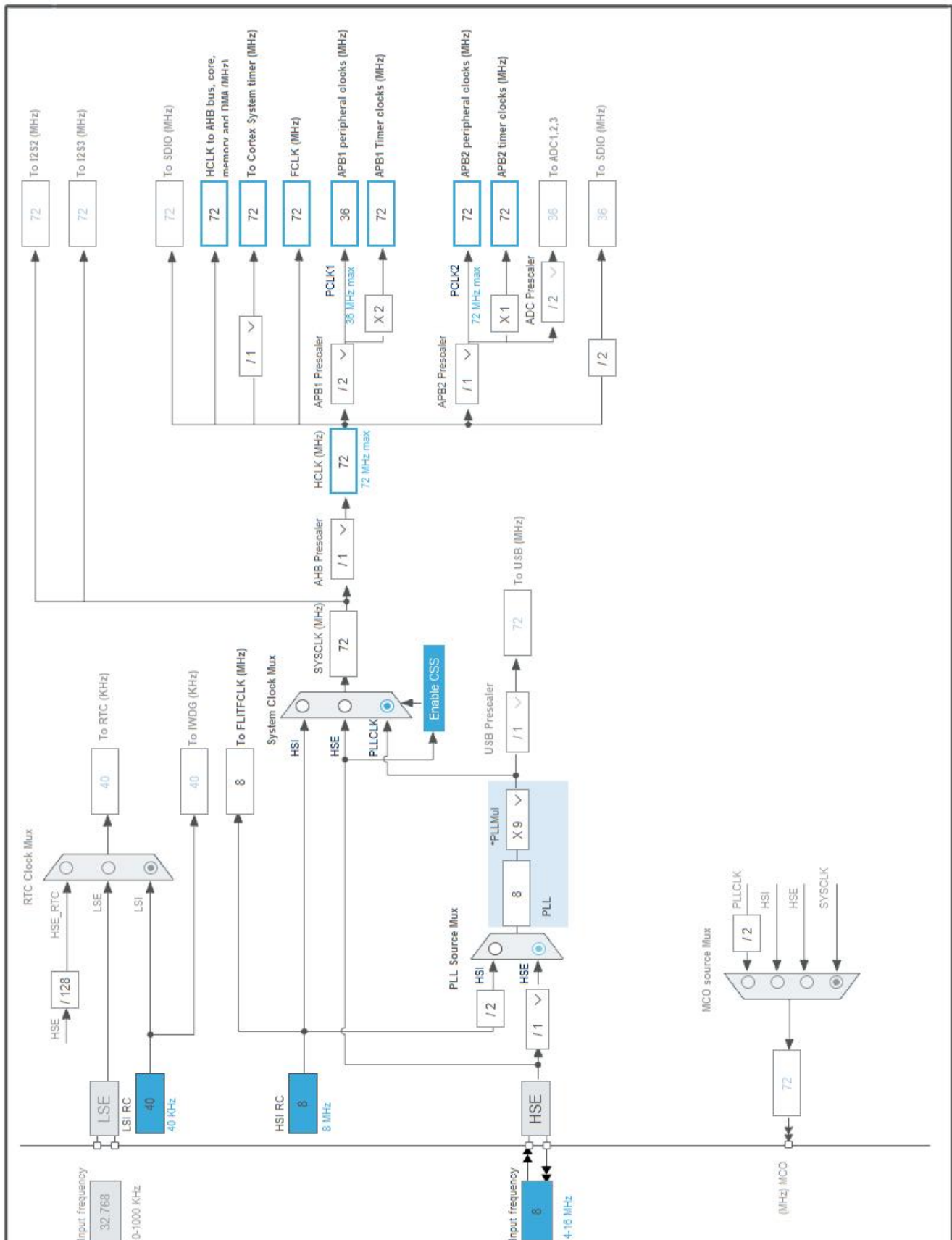


3. Pins Configuration

Pin Number LQFP64	Pin Name (function after reset)	Pin Type	Alternate Function(s)	Label
1	VBAT	Power		
5	PD0-OSC_IN	I/O	RCC_OSC_IN	
6	PD1-OSC_OUT	I/O	RCC_OSC_OUT	
7	NRST	Reset		
12	VSSA	Power		
13	VDDA	Power		
18	VSS	Power		
19	VDD	Power		
31	VSS	Power		
32	VDD	Power		
41	PA8 *	I/O	GPIO_Output	
46	PA13	I/O	SYS_JTMS-SWDIO	
47	VSS	Power		
48	VDD	Power		
49	PA14	I/O	SYS_JTCK-SWCLK	
54	PD2 *	I/O	GPIO_Output	
60	BOOT0	Boot		
63	VSS	Power		
64	VDD	Power		

* The pin is affected with an I/O function

4. Clock Tree Configuration



5. Software Project

5.1. Project Settings

Name	Value
Project Name	lab1
Project Folder	C:\BCSpace\STM32_Project\lab1
Toolchain / IDE	STM32CubeIDE
Firmware Package Name and Version	STM32Cube FW_F1 V1.8.1

5.2. Code Generation Settings

Name	Value
STM32Cube MCU packages and embedded software	Copy only the necessary library files
Generate peripheral initialization as a pair of '.c/.h' files	Yes
Backup previously generated files when re-generating	No
Delete previously generated files when not re-generated	Yes
Set all free pins as analog (to optimize the power consumption)	No

6. Power Consumption Calculator report

6.1. Microcontroller Selection

Series	STM32F1
Line	STM32F103
MCU	STM32F103RCTx
Datasheet	14611_Rev12

6.2. Parameter Selection

Temperature	25
Vdd	3.3

6.3. Battery Selection

Battery	Li-SOCL2(A3400)
Capacity	3400.0 mAh
Self Discharge	0.08 %/month
Nominal Voltage	3.6 V
Max Cont Current	100.0 mA
Max Pulse Current	200.0 mA
Cells in series	1
Cells in parallel	1

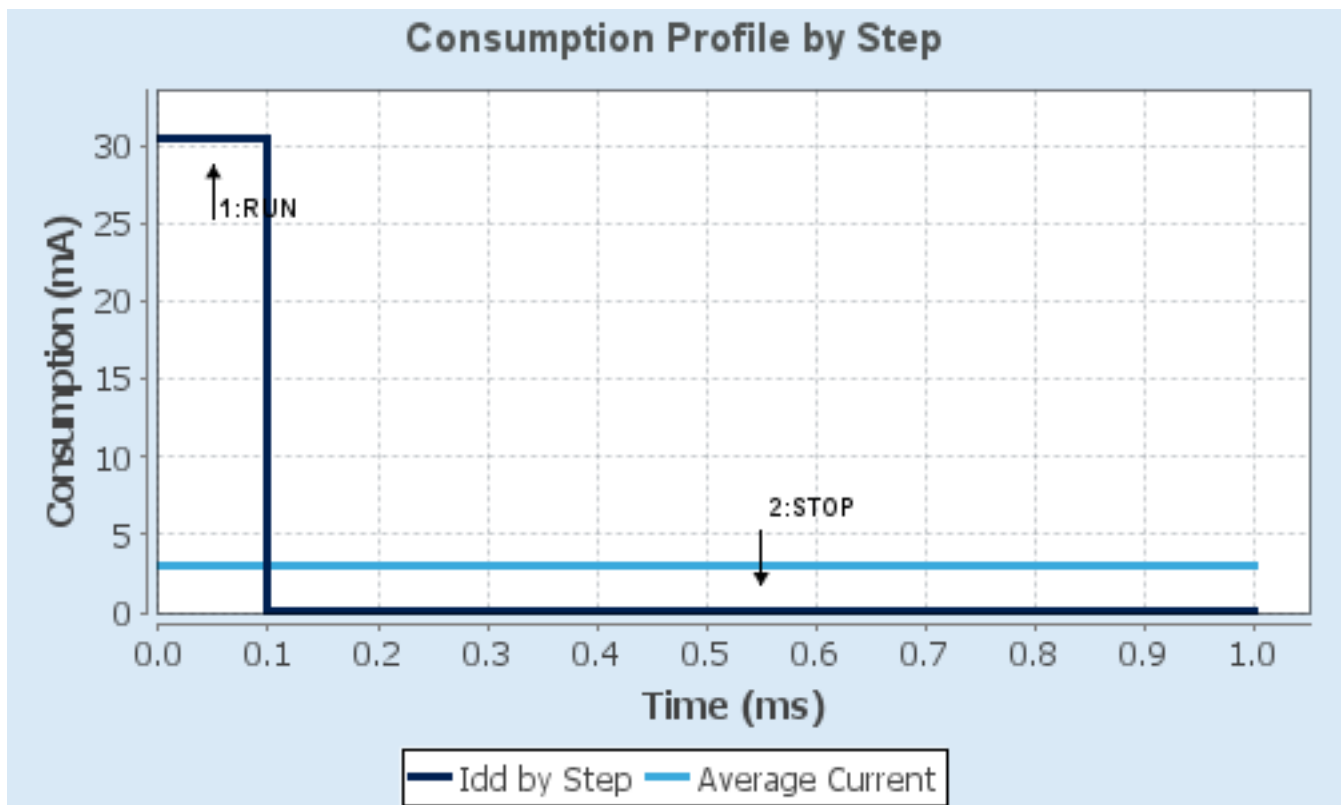
6.4. Sequence

Step	Step1	Step2
Mode	RUN	STOP
Vdd	3.3	3.3
Voltage Source	Battery	Battery
Range	No Scale	No Scale
Fetch Type	FLASH	n/a
CPU Frequency	72 MHz	0 Hz
Clock Configuration	HSE PLL	Regulator LP
Clock Source Frequency	8 MHz	0 Hz
Peripherals		
Additional Cons.	0 mA	0 mA
Average Current	30.5 mA	25 μ A
Duration	0.1 ms	0.9 ms
DMIPS	90.0	0.0
Ta Max	100.47	105
Category	In DS Table	In DS Table

6.5. RESULTS

Sequence Time	1 ms	Average Current	3.07 mA
Battery Life	1 month, 15 days, 15 hours	Average DMIPS	61.0 DMIPS

6.6. Chart



7. IPs and Middleware Configuration

7.1. GPIO

7.2. RCC

High Speed Clock (HSE): Crystal/Ceramic Resonator

7.2.1. Parameter Settings:

System Parameters:

VDD voltage (V)	3.3
Prefetch Buffer	Enabled
Flash Latency(WS)	2 WS (3 CPU cycle)

RCC Parameters:

HSI Calibration Value	16
HSE Startup Timeout Value (ms)	100
LSE Startup Timeout Value (ms)	5000

7.3. SYS

Debug: Serial Wire

Timebase Source: SysTick

* User modified value

8. System Configuration

8.1. GPIO configuration

IP	Pin	Signal	GPIO mode	GPIO pull/up pull down	Max Speed	User Label
RCC	PD0-OSC_IN	RCC_OSC_IN	n/a	n/a	n/a	
	PD1-OSC_OUT	RCC_OSC_OUT	n/a	n/a	n/a	
SYS	PA13	SYS_JTMS-SWDIO	n/a	n/a	n/a	
	PA14	SYS_JTCK-SWCLK	n/a	n/a	n/a	
GPIO	PA8	GPIO_Output	Output Push Pull	No pull-up and no pull-down	Low	
	PD2	GPIO_Output	Output Push Pull	No pull-up and no pull-down	Low	

8.2. DMA configuration

nothing configured in DMA service

8.3. NVIC configuration

Interrupt Table	Enable	Preenmption Priority	SubPriority
Non maskable interrupt	true	0	0
Hard fault interrupt	true	0	0
Memory management fault	true	0	0
Prefetch fault, memory access fault	true	0	0
Undefined instruction or illegal state	true	0	0
System service call via SWI instruction	true	0	0
Debug monitor	true	0	0
Pendable request for system service	true	0	0
System tick timer	true	0	0
PVD interrupt through EXTI line 16	unused		
Flash global interrupt	unused		
RCC global interrupt	unused		

* User modified value

9. Predefined Views - Category view : Current

Middleware

System Core

Analog

Timers

Connectivity

Multimedia

Computing

DMA

GPIO 

NVIC 

RCC 

SYS 

10. Software Pack Report